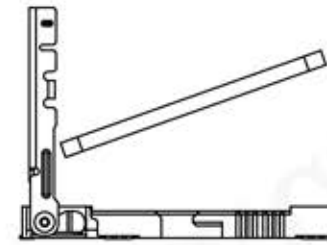
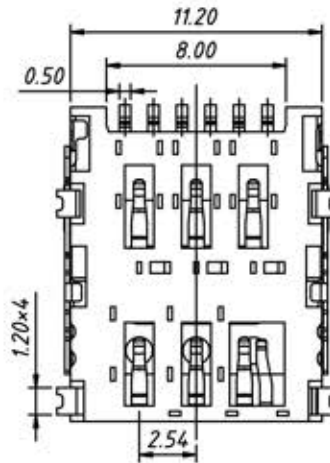
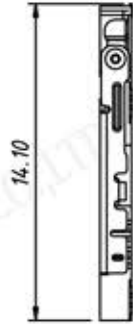
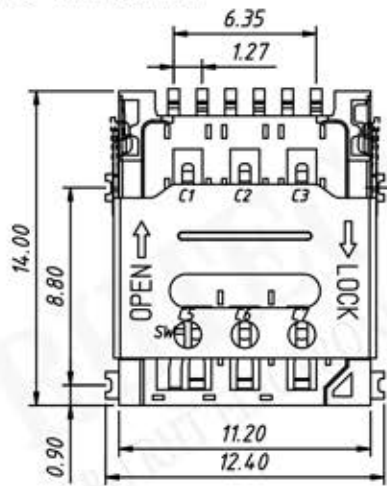
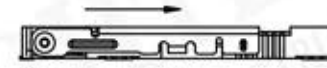


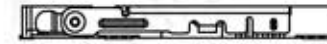
P/N: RE-C-SIM-077A



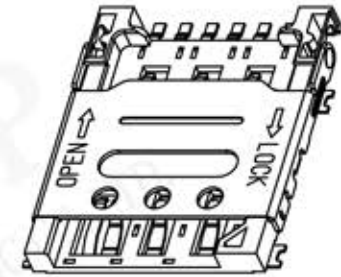
STEP 1 INSERT NANO SIM CARD



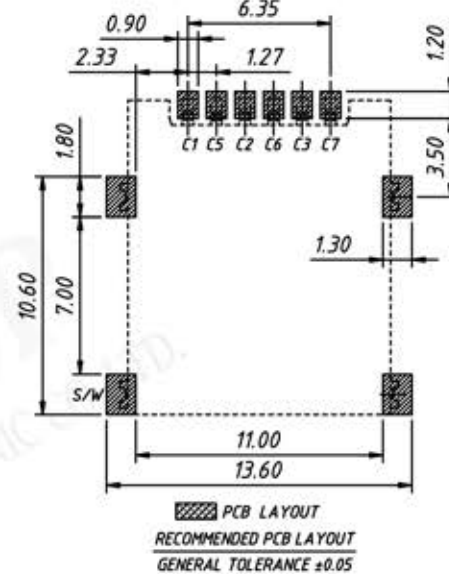
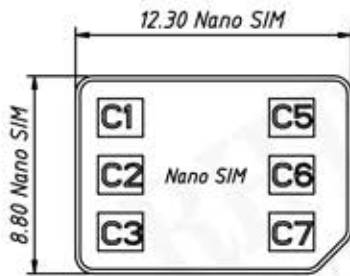
STEP 2 PUSH THE SHELL



STEP 3 FINISH



Material:
 Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: Copper Alloy, Plated 50u"
 Ni Overall Contact All Au 1U.
 Shell: SUS. All Ni 30U/MIN.



Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
S/W	SWITSH PIN

Electrical:
 Current Rating: 0.5A AC/DC MAX.
 Voltage Rating: 125V AC/DC
 Ambient Temperature Range: -20oC ~ +60oC
 Storage Temperature Range: -40oC ~ +70oC
 Ambient Humidity Range: 95% R.H. Max.
 Contact Resistance: 80mΩ Max.
 Insulation Resistance: 100MΩ Min./100V DC
 Mating Cycles: 5000 Insertions.
 Reflow peak temp: 260oC ±5oC, 3~5 s

